TALL LAPERSS S.S.C. 371

PATENT NUMBER and ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	2022	EXAMINER		
10009196	04/15/2002	438	5.	2817		GEYER		
**APPLICANT	S: Saijo Ki	inji; Yoshi	da Kazuo; Oka	amoto H	iroaki; Ohs	awa Shinji;		
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**CONTINUIN	G DATA VERIFIEI	D:						
THIS APPLICATION IS A 371 OF PC1/JP00/03746 05/09/2000								
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	PPLICATIONS VE	RIFIED:		•		•		
JAPAN 11/164	,454 06/10/1999	586		•				
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Foreign priority cla			s □ no		ATTORN	NEY DOCKET NO		
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ITLE : Clad pl	ate for forming inte	rposer fo	r semiconduct	or device	e, interpose	er for semiconductor		
levice, and me	thod of manufactur	ring them			U.S.DEPT.	OF COMM./PAT.& TM-PTO-436L(Rev		

NOTICE OF ALLOWANCE MAILED		100 18 May	CLAIMS ALLOWED				
		Assistant Examiner	Total Claims	Prin O.G	t Claim for		
ISSUE FEE			DRAWING				
Amount Due	Date Paid		Sheets Drwg.	Figs.Drwg.	Print Fig.		
	<u> </u>	Primary Examiner					
TERMINAL DISCLAMER		PREPARED FOR ISSUE	Applicati n Examiner				
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